

REMARKS

Claims 25-38 stand rejected in the Office Action. Claims 20-24 have been withdrawn from consideration in response to the Restriction Requirement and are canceled with this amendment. Claims 25, 28, and 32 have been amended in this Response, while new claim 39 is offered. Upon entry of the amendments, claims 25-39 remain pending in the Application.

Claim 28 has been amended to correct claim dependency. Support for the Amendment to claim 25 is found in the specification as originally filed, for example on page 3, lines 14-17 and on page 7, lines 10-17. Support for the amendment to claim 32 is also found in the passages supporting the Amendment to claim 25. Support for new claim 39 is found in the specification, for example on page 6, lines 10-12. Applicants respectfully request entry of the amendments.

CLAIM OBJECTIONS

Applicants have corrected the dependency of claim 28, as suggested by the Examiner. It is believed that the amendments to claim 28 suffice to remove the claim objection.

REJECTION UNDER 35 U.S.C. § 102

Claims 25, 29, 30, 31 and 32 stand rejected under 35 U.S.C. § 102(b) as being anticipated by Dash (U.S. Pat. No. 2,491,479).

The Examiner states that the Dash reference shows arc welding an aluminum stud to an aluminum plate. The Examiner further asserts that, since the aluminum alloy is taught as containing 0.2% titanium, the titanium would inherently comprise the surface of the stud. Applicants respectfully traverse the rejection as applied to the amended claims and request reconsideration.

Applicants have amended claim 25 and 32 to more clearly define the invention. In particular, Applicants have added language supported by the specification that the titanium on the surface on the head of the aluminum weld stud is provided in the form of a layer of titanium containing material. Such a limitation is not present in the Dash reference—as noted above, the Dash reference teaches the titanium is merely part of the aluminum alloy, and is not present as a layer on the surface. Rejected claims 29-31 depend from claim 25 and so include the limitation that the titanium containing material is present as a layer on the surface of the stud. Because the amended claims contain at least one element or limitation not found in the Dash reference, they are patentable over the Dash reference under § 102. Accordingly, Applicants respectfully request that the rejection of claims 25, 29, 30, 31, and 32 over the Dash reference be withdrawn.

REJECTION UNDER 35 U.S.C. § 103

Claims 26-28, and 33-38 stand rejected under 35 U.S.C. § 103(a) as being unpatentable over the Dash reference as applied to claims 25 and 32, and further in view of Martin (U.S. Patent 2,670,424) and Konnert (U.S. Patent 4,326,894). The Martin reference appears to be cited for a teaching of a weld stud coated with titanium, and the Konnert reference appears to teach applying a titanium material to a surface by using an acidic solution comprising titanium ions. The Office Action states that the teachings of the Martin reference and the Konnert reference make-up for the deficiency of the Dash reference, which does not disclose applying a coating to a stud surface with an acidic solution. Applicants respectfully traverse the rejections and respectfully request reconsideration.

For a rejection of claims over a combination of references under § 103, the references when combined must teach or disclose every element of the claims. Further, there must be a

motivation to combine the teachings of the references in order to arrive at the subject matter of the claims. Just because references can be combined to arrive at the claimed subject matter, such combination is not obvious unless there is a suggestion that it would be desirable to do so. In assessing the teaching of cited references, it is appropriate to consider the entire teaching of the references and the interpretation a person of skill in the art would apply to those teachings. In particular, portions of the reference that teach away from making the combination should be considered in determining whether the invention as a whole would have been obvious to a person of skill in the art.

As noted above, the Dash reference does not disclose a layer of titanium on an aluminum weld stud, as recited by the amended claims 25 and 32. Accordingly, these and other features of claims 26-28 and 33-38 must be supplied by the cited references Martin and Konnert. Dash discloses an aluminum stud, but it does not teach a coating of titanium on the stud.

The Martin reference teaches away from coating an aluminum stud with titanium. Martin is drawn to the welding of steel or steel alloy studs to plates made of steel. Column 1, line 12-14. Aluminum is preferred for metallizing a steel stud, but other alloys having the required characteristics may be used depending on the material the stud is made of. Column 3, lines 9-13. The required characteristics include that the metal for metallizing the (steel) surface of the stud have a higher conductivity than the stud material. Column 2, lines 42-45.

In the current claims, on the other hand, the metal (titanium) forming a coating on the studs has a lower conductivity than the stud metal (aluminum). Thus, while Martin teaches aluminum is preferred to put on an iron or steel stud, it specifically teaches away from using a poorly conductive metal, such as titanium, to coat a highly conductive material such as aluminum.

The relative conductivities just mentioned are well-known and can be looked up in standard treatises. For example, it is known that aluminum is more conductive than iron or steel, and that titanium is less conductive than aluminum. Attention is respectfully drawn to the attached web page from the Newsletter of the American Metal Market, available at www.amm.com. The relative conductivity of aluminum (based on copper as 100) is given as from 39-59 while the relative conductivity of titanium is given as 5 and that of steel is given as 3-15. Thus, the conductivity of the titanium is nearly an order of magnitude lower than that of aluminum. The conductivity measurements in the table are consistent with values of resistivity available in standard treatises such as the attached pages from the Metal Handbook, 8th Edition, published by The American Society for Metals. The electrical resistivity of titanium is given as 42 microhm-cm, while the resistivity of aluminum is given as 2.6548 microhm-cm. Because the electrical resistivity is the reciprocal of the electrical conductivity, the Metals Handbook data show the electrical conductivity of titanium is more than an order of magnitude less than the conductivity of aluminum.

Other passages in the Martin reference do not reverse the express teaching away from titanium on aluminum. The Martin reference teaches that is preferred to metallize a steel stud with aluminum, but does indicate that other metals may be placed on studs made of other materials. However, the reference is very clear to state that other metals or alloys chosen for the metallization must have the required characteristics (column 3, lines 11, discussed above). Since the required characteristics include a metal having a higher conductivity than the material of the stud, this amounts to an express teaching that metals of low conductivity (such as titanium) are to be avoided when using a highly conductive material such as aluminum for the stud.

Further, the Martin reference states that there is “no limitation...as to the specific metallizing materials”. Column 4, lines 38-40. But these lines directly contradict the earlier teaching that metals must have required characteristics, including higher conductivity than the stud material. Because even the claims of the reference recite the “higher electrical conductivity” feature of the metallizing material, the person of skill in the art would discount the statement that there is no limitation. The reference at Column 4 goes on to suggest for the use with steel or steel alloy studs, other metals such as titanium, manganese, and vanadium can be used. But this is no teaching to coat an aluminum stud with titanium. In light of the reference’s express teaching against combining titanium with an aluminum stud, Applicants respectfully submit that the reference at Column 4 does not motivate one of skill in the art to modify the disclosure of the Dash to arrive at the subject matter.

The Konnert reference does not overcome the deficiencies of the Dash and Martin references as just discussed. The Konnert reference is directed to preparing conversion coatings. The reference simply does not motivate one of skill in the art to apply a titanium coating to an aluminum stud in light of the teachings of the Martin reference discussed above. For this reason, Applicants respectfully submit that there is no motivation to combine the references.

For the reasons discussed above, Applicants respectfully submit the amended claims are patentable over the cited references. Accordingly, Applicants respectfully request the rejection be withdrawn.

Claim 39 adds a further limitation that distinguishes the claimed invention from the cited references. None of the references alone or in combination teach or suggest providing a (titanium) layer of sufficient thickness to prevent formation of aluminum oxide on the stud. For this and the reasons discussed above, Applicants believe claim 39 is patentable over the cited

references.

CONCLUSION

It is believed that all of the stated grounds of rejection have been properly traversed, accommodated, or rendered moot. Applicant therefore respectfully requests that the Examiner reconsider and withdraw all presently outstanding rejections. It is believed that a full and complete response has been made to the outstanding Office Action, and as such, the present application is in condition for allowance. Thus, prompt and favorable consideration of this amendment is respectfully requested. If the Examiner believes that personal communication will expedite prosecution of this application, the Examiner is invited to telephone the undersigned at (248) 641-1600.

Respectfully submitted,

Dated: January 28, 2004

By: Robert M. Siminski
Robert M. Siminski,
Reg. No. 36,007

HARNESS, DICKEY & PIERCE, P.L.C.
P.O. Box 828
Bloomfield Hills, Michigan 48303
(248) 641-1600

RMS/MAF/cg

Electrical Conductivity of Metals

This page is best viewed in Netscape 2.0+ or other table-capable browsers.

The table originally appeared in AMM's annual Metal Statistics book.

Metal	Relative Conductivity*	Temperature Coefficient of Resistance**	Tensile Strength (lbs./sq. in.)	Composition of Earth's Crust (% by Weight)
Aluminum (2S; pure)	59	0.0039	30,000	8.1
Aluminum (alloys):				
• Soft-annealed	45-50	—	—	—
• Heat-treated	30-45	—	—	—
Brass	28	0.002-0.007	70,000	—
Cadmium	19	0.0038	—	.0001
Chromium	55	—	—	.02
Climax	1.83	0.0007	150,000	—
Cobalt	16.3	0.0033	—	.002
Constantin	3.24	0.00001	120,000	—
Copper:				
Hard drawn	89.5	0.00382	60,000	—
• Annealed	100	0.00393	30,000	.007
Everdur	6	—	—	—
Gold	65	0.0034	20,000	.0000005
Iron:				
• Pure	17.7	0.005	—	5.0
• Cast	2-12	—	—	—
• Wrought	11.4	—	—	—
Lead	7	0.0039	3,000	.002
Magnesium	—	0.004	33,000	2.1
Manganin	3.7	0.00001	150,000	—
Mercury	1.66	0.00089	0	.00005
Molybdenum	33.2	0.004	—	.001
Monel	4	0.002	160,000	—
Nichrome	1.45	0.0004	150,000	—
Nickel	12-16	0.006	120,000	.008
Nickel silver (18%)	5.3	0.00014	150,000	—
Phosphor bronze	36	0.0018	25,000	—
Platinum	15	0.003	55,000	.0000005
Silver	106	0.0038	42,000	.00001
Steel	3-15	0.004-0.005	42,000-230,000	—
Tin	13	0.0042	4,000	.004
Titanium	5	—	50,000	.4
Titanium, 6Al4V	5	—	130,000	—
Tungsten	28.9	0.0045	500,000	.007
Zinc	28.2	0.0037	10,000	.01

* At 20° Celsius, based on copper as 100.

** Per degree C at 20° C.

Note: The conductivity of various metals is subject to variation according to processing and alloy composition.

(LEFT) A single crystal of antimony, cleared and deeply etched by an acid mixture along (111) planes (Bell Telephone Laboratories, Inc.). (RIGHT) Sahara desert sand dunes in southern Libya (Aero Service Corp.).

McGraw-Hill Encyclopedia of Science and Technology
Copyright © 1960 by the McGraw-Hill Book Company, Inc. Printed in the United States of America. All rights reserved. This book, or parts thereof, may not be reproduced in any form without permission of the publishers. Philippines Copyright, 1960, by the McGraw-Hill Book Company, Inc.

Library of Congress Catalog Card Number: 60-11000

The basic plan of the
here in order to facilitate

The subject matter of
branches of science and
systematically: a general
survey of the field, and a
alphabetically arranged, c
and more specific aspects.

Cross references guide t
articles to the other artic
is subdivided, and from
highly specialized phases
references—there are ab
printed in small capital l
easily recognized. By mea
a reader may find his way
ING, through ELECTRONIC
ELECTRON MOTION IN VACU
Or, following another lin
reader would be led to
TRANSMISSION LINES, ELE
so on.

In general, each article
the title that states its sc
only the scientific or techn
Most of the articles, after
increasingly complex and
reader thus needs to pr
inclinations and requireme

The Index, Volume 15
locate the discussion of
cyclopedia but not given i

Every phylum, class, a
animal kingdoms is allotte
of the more common fan
are covered either in one
a separate article under its
name.

The adjectives electric
the following senses. Electr
arising from, actuated by,

In re-
over a
voltage
ial rise
which
walls.
sult of

oduces
lectron
bed by
e addi-
rection
ed per
athode
by

initial
Town-
coeffi-

ase in
end of
apidly
ts are
ss and
bed by

t, i_0 is
nd i is
epara-

nes in-
ot too
inuous
spark,
break-
called
tained.
ere re-
BREAK-

ential,
ie self-
ensive

obstan-
a glow
of the
At this
hieved
urge is
stic is
is por-
econd-
y vital
econd-
HARGE.
nother
region
mode

is the low cathode potential fall and the very high current density. It is generally felt that the pre-dominant effect in the production of the large number of electrons at the cathode necessary for the arc is thermionic emission. This is consistent with the very high temperatures known to exist either generally or locally on the cathode. Although the arc type of discharge has very great commercial value, the mechanism of its operation is not very well understood.

In addition to these general types of conduction, there are very special cases of considerable interest. Some of these are the corona discharge, radio-frequency or electrodeless discharge, hot-cathode discharge, and discharges in the presence of a magnetic field. [C.H.M.]

Bibliography: G. P. Harnwell, *Principles of Electricity and Electromagnetism*, 2d ed., 1949; L. B. Loeb, *Fundamental Processes of Electrical Discharge in Gases*, 1939; J. Millman and S. Seely, *Electronics*, 2d ed., 1951.

Electrical conductivity of metals

Electric currents in metals are caused by mobile, relatively free electrons that are not bound to any particular atom and can wander throughout the metal. In general, the conductivity of metals is higher than that of other materials, and decreases with rising temperature. At temperatures near absolute zero, certain metals become superconductors, possessing infinite conductivity. For an extended discussion of this phenomenon, see SUPERCONDUCTIVITY. The conductivities of a number of common metals at 0°C are as follows:

Metal	Conductivity, (ohm-meter) ⁻¹
Silver	66
Copper	64.5
Gold	49
Aluminum	40
Magnesium	25.4
Sodium	23.4
Tungsten	20.4
Potassium	16
Lithium	11.8
Iron	11.5
Cesium	5.2

The current density (current per unit area) in a conductor is proportional to the electric field in the conductor; that is, $J = \sigma \cdot E$ where J is the current density and E is the electric field intensity. The proportionality constant σ is called the electrical conductivity. In mks units J is in amperes per square meter, E is in volts per meter and σ has the dimensions of (ohm-meter)⁻¹. In isotropic or nearly isotropic materials, such as polycrystalline metals or liquids, J is in the same direction as E , and σ reduces to a scalar constant. In this case σ is simply the reciprocal of the resistivity ρ (see RESISTIVITY, ELECTRICAL). In general, however, σ must be defined as a tensor, called the conductivity tensor.

Electrons possess negative charge; hence the direction of current flow is opposite to that of the flow of electrons. In a solid, however, electrons may, under certain conditions, move under the influence of an electric field in such a manner that the net effect is the same as though positively charged carriers of approximately electronic mass were responsible for the current flow. It is then common to speak of current due to holes, these holes being thought of as charge carriers of positive mass and charge (see HOLES IN SOLIDS). Frequently, especially in the case of polyvalent metals (and also in semiconductors), the experimental results are described most conveniently by assuming that holes, as well as ordinary electrons, contribute to charge flow. In the theory of conductivity one then speaks of a two-band model.

In the more general sense the theory of electrical conductivity of metals encompasses all phenomena which relate to the transport of electrons in metals. This includes the thermoelectric effects (Peltier, Thomson, and Seebeck effects), the isothermal magnetic effects (Hall, Corbino, and magnetoresistance effects), and the thermomagnetic effects (Nernst, Ettinghausen, and Righi-Leduc effects). Moreover, since transport of charge is accompanied by transport of electronic mass and energy, the general formulation of the theory also contains within its framework the theory of that portion of the thermal conductivity which is due to the presence of mobile electrons or holes in the metal. See CONDUCTION (HEAT); see also BOLTZMANN TRANSPORT EQUATION; FREE-ELECTRON THEORY OF METALS; HALL EFFECT; MAGNETORESISTANCE; RELAXATION TIME (ELECTRONS); THERMOELECTRICITY; THERMOMAGNETIC EFFECTS; WIEDEMANN-FRANZ LAW. [F.J.B.]

Electrical degree

A unit equal to $\frac{1}{360}$ of a complete cycle of electric current or voltage. In an electric machine it is $\frac{1}{360}$ of the angle subtended at the axis by two consecutive field poles of like polarity, since the voltage wave generated in a conductor completes one cycle when it traverses one pair of poles. The term mechanical degree is used to designate the space angle between the two positions about the axis of the machine. The number of electrical degrees equals the number of mechanical degrees multiplied by the number of pairs of poles on the machine. [A.R.E.]

Electrical engineering

A branch of engineering dealing primarily with electricity and magnetism and devoted to utilization of the forces of nature and materials for the benefit of mankind (see ENGINEERING). Electrical engineering encompasses many phases of other engineering sciences and the physical sciences; it includes research, invention, development design, application, and education. Many phases of electrical engineering are based on applications of higher mathematics.

The great advances of engineering are closely associated with the uses of electricity and magnetism. The history of electrical engineering is a history of accelerated engineering progress, closely identified with the work of relatively few scientists among the historical development of electrical engineering, and considering five eras of development.

First era. As early as the thirteenth century, experimental behavior of static electricity (see ELECTRICITY, 1603), personal physician experimented with electricity. In 1750 Benjamin Franklin was electrical in nature. It covered anything that was a standpoint of the application of the presence of rocks preceded the earliest. Such knowledge was Applications of electrical completely absent in this era. NETISM.

Second era. The second in electrochemical development deposition was discovered by A. Carlisle in 1800 and in 1800 discovered the principle. The voltaic cell was one of the discoveries in the history because it provided a continuous amount of electric power voltage. See BATTERY (ELECTRICITY). It was used as an essential communication systems, such as telegraph.

The most significant development era centered around the first. The first United States telegraph was obtained by the invention of a practical telegraph, announced by Joseph Henry in 1830 by Groat and Henry opened significant invention, the electric telegraph. The principle of this forerunner of the telegraph industry was conceived in 1837, and patented by Morse.

Few developments have been made in American life than Morse paved the way for the first communication, the telegraph, the telephone and later the radio. The growth of electrical engineering in extensive engineering, equipment, and the birth of adding much to the wealth at the same time making progress throughout the nation. ELECTRICAL.

METALS HANDBOOK

8th Edition

VOL. 1

Properties and Selection of Metals

*prepared under the direction of the
METALS HANDBOOK COMMITTEE*

TAYLOR LYMAN, Editor

HOWARD E. BOYER, Managing Editor

PAUL M. UNTERWEISER, Associate Editor

JOS. E. FOSTER, Associate Editor

JAMES P. HONTAS, Associate Editor

HELEN LAWTON, Assistant Editor



AMERICAN SOCIETY FOR METALS
Metals Park, Ohio

Copyright © 1961
BY THE
AMERICAN SOCIETY FOR METALS

No part of this book may be reproduced, stored in a retrieval system, or transmitted, in any form or by any means, electronic, mechanical, photocopying, recording, or otherwise, without the prior written permission of the publisher.

First printing, January 1961
Second printing, December 1961
Third printing, March 1964
Fourth printing, May 1966
Fifth printing, July 1967
Sixth printing, September 1969
Seventh printing, May 1972

Nothing contained in the Metals Handbook is to be construed as a grant of any right of manufacture, sale, or use in connection with any method, process, apparatus, product, or composition, whether or not covered by letters patent or registered trade mark, nor as a defense against liability for the infringement of letters patent or registered trade mark.

PRINTED IN THE UNITED STATES OF AMERICA

PURE METALS

CONTENTS

Aluminum	1197	Germanium	1205	Osmium	1217	Sodium	1222
Antimony	1197	Gold	1185	Palladium	1193	Tantalum	1222
Arsenic	1198	Hafnium	1205	Platinum	1189	Tellurium	1224
Beryllium	1198	Holmium	1230	Plutonium	1218	Terbium	1230
Bismuth	1199	Indium	1206	Potassium	1219	Thallium	1224
Cadmium	1199	Iridium	1196	Praseodymium	1230	Thorium	1224
Calcium	1199	Iron	1206	Rare Earth Metals	1230	Thulium	1230
Cerium	1230	Lanthanum	1230	Rhenium	1220	Tin	1142
Cesium	1200	Lead	1062	Rhodium	1196	Titanium	1225
Chromium	1200	Lithium	1213	Rubidium	1220	Tungsten	1225
Cobalt	1201	Lutetium	1230	Ruthenium	1220	Uranium	1226
Columbium	1202	Magnesium	1213	Samarium	1230	Vanadium	1227
Copper	1203	Manganese	1215	Scandium	1230	Ytterbium	1230
Dysprosium	1230	Mercury	1215	Selenium	1221	Yttrium	1227
Erbium	1230	Molybdenum	1215	Silicon	1221	Zinc	1169
Europium	1230	Neodymium	1230	Silicon (Semi-conductor Grade)	1222	Zirconium	1228
Gadolinium	1230	Nickel	1217	Silver	1181	Rare Earth Metals	1230
Gallium	1204	Niobium	1202				

Aluminum (99.996%)

Compiled by A. W. DEMMLER, JR.*

- C 1 *Density*. At 68 F (20 C), 2.6989 g per cu cm (0.09751 lb per cu in.); at 77 F (25 C), 2.6978 g per cu cm (0.09747 lb per cu in.)
D 2 *Melting point*. 1220.4 F (660.2 C)
4 *Boiling point*. 4442 F (2450 C)
6 *Thermal expansion*.

Temperature range, C	Average coefficient, micro-in./in./°C
-200 to 20	18.0
-150 to 20	19.9
-100 to 20	21.0
-50 to 20	21.8
20 to 100	23.6
20 to 200	24.5
20 to 300	25.5
20 to 400	26.4
20 to 500	27.4

- range between $\lambda = 2200$ and 2500 \AA ; 96% for $\lambda = 10,000 \text{ \AA}$ (1 micron); 97% for $\lambda = 11,000$ to $100,000 \text{ \AA}$ (1.1 to 10 microns)
5 *Emissivity* at 77 F (25 C). 0.030 in air
G 2 *Magnetic susceptibility*. 0.6×10^{-6} cgs
J 1 *Crystal structure*. Face-centered cubic; $a = 4.0491 \text{ \AA}$
K 1 *Mechanical properties*. Modulus of elasticity, 9,000,000 psi

Property	Annealed	Cold rolled 75%
Tensile strength, psi ...	6,800	16,300
Yield strength, psi	1,700	15,400
Elongation, % (a)	60	5
Brinell hardness (b) ...	17	27

(a) Sheet specimens.
(b) 500-kg load, 10-mm ball.

Antimony

Compiled by K. C. Lit

- 11 *Specific heat* at 212 F (100 C). 0.224 cal per g
13 *Latent heat of fusion*. 94.5 cal per g
18 *Heat of combustion*. 7420 cal per g to $\alpha\text{Al}_2\text{O}_3$ at 77 F (25 C)
E 1 *Electrical conductivity*. 64.94% IACS
2 *Electrical resistivity* at 68 F (20 C). 2.6548 microhm-cm
5 *Temperature coefficient of electrical resistivity*, 68 F (20 C). 0.00429 per °C
F 1 *Reflectivity*. 90% for white light from a tungsten filament; 86 to 87% in

*Aluminum Co. of America

†President, Wah Chang Corp.

- 6 *Thermal expansion* 68 to 140 F (20 to 60 C). 0.0000085 to 0.0000108 per °C, the value depending on the crystal orientation in the polycrystalline material.
11 *Specific heat* at 68 F (20 C). 0.049 cal per g
13 *Latent heat of fusion*. 38.3 cal per g
15 *Latent heat of vaporization*. 373 cal per g
16 *Thermal conductivity*. 0.045 cal/sq cm/cm/sec/°C
E 2 *Electrical resistivity* at 32 F (0 C). 39.0 microhm-cm
F 1 *Reflectivity*. 70% at $\lambda = 5890 \text{ \AA}$
G 2 *Mass magnetic susceptibility*. -0.87 cgs
I 2 *Resistance to specific agents*.

Corrosive agent	Resistance
Air	Moderate general attack when air is moist and light is present

Alkalis and alkali salts	Resistance
Ammonia	Resistant
Aqua regia	Severe general attack
Carbon dioxide	Resistant
Chlorine	Severe general attack
Hydrochloric acid	Moderate attack in presence of air
Hydrofluoric acid	Resistant
Nitric acid	Severe general attack
Sulfuric acid	Severe general attack by warm concentrated acid; resistant to cold or dilute acid

This section was compiled with the help of the ASM Committee on Pure Metals, with membership as follows: WM. A. PENNINGTON, *Chairman*, Professor of Metallurgy, University of Maryland; C. S. BARRETT, Professor, Institute for the Study of Metals, University of Chicago; J. H. BECHTOLD, Manager, Metallurgy Dept., Research Laboratories, Westinghouse Electric Corp.; EDWARD EPREMIAN, Technical Advisor, Union Carbide Metals Co., Union Carbide Corp.

J. W. FREDRICKSON, Head, Fundamental and Exploratory Div., Metallurgical Laboratory, Dow Metal Products Co.; BRUCE W. GONSER, Technical Director, Battelle Memorial Institute; CLIF-

FORD A. HAMPEL, Manager, Chemical Equipment Div., Fansteel Metallurgical Corp.; EARL T. HAYES, Chief Metallurgist, U. S. Bureau of Mines; HUGH B. HIX, Research Supervisor, Experimental Station, E. I. du Pont de Nemours & Co., Inc.; WILLIAM P. ROE, Research Supervisor, American Smelting and Refining Co.

F. J. SHORTSLEEVE, Director of Research, Union Carbide Metals Co., Union Carbide Corp.; F. H. SPEDDING, Director, Institute for Atomic Research, Iowa State College; MORRIS A. STEINBERG, Head, Metallurgy Dept., Horizons, Inc.; H. C. VACHER, Metallurgist, National Bureau of Standards; E. M. WISE, Assistant to Vice President - Research, International Nickel Co., Inc.

Titanium (99.9%)

Compiled by W. STUART LYMAN*

- dissociation pressure. It is also used as a deoxidant and in electronic tubes and lamps for controlling starting voltages and maintaining stability.
- 2 **Precautions in use.** Thorium is a reactive metal and, depending on its chemical and physical form, is potentially toxic chemically and radiologically.
- C 1 **Density at 77 F (25 C).** X-ray: 11.72 g per cu cm; bomb-reduced (as cast): 11.5 to 11.6 g per cu cm; arc-melted iodide: 11.66 g per cu cm
- D 1 **Melting point.** 3182 F (1750 C)
- 4 **Boiling point.** 6332 to 7592 F (3500 to 4200 C)
- 6 **Thermal expansion (linear), 77 to 1832 F (25 to 1000 C).** 12.5 micro-in. per in. per °C (iodide thorium)
- 13 **Latent heat of fusion.** <4600 cal per mol
- 15 **Latent heat of vaporization.** 130,000 to 145,000 cal per mol
- 16 **Thermal conductivity at 212 F (100 C).** 0.090 cal/cm/sec/°C
- E 2 **Electrical resistivity at 273 K.** 13 microhm-cm
- 5 **Temperature coefficient of electrical resistivity, 32 to 212 F (0 to 100 C).** 0.0038 per °C
- 15 **Hall coefficient.** -8.8×10^{-5} cu cm per coulomb
- F 4 **Color.** Silvery white
- G 2 **Mass magnetic susceptibility at 90 K.** 0.66×10^{-6} emu per g
- I 1 **General resistance to corrosion.** Reacts readily in air and rather slowly in water (at 212 F). Below 1650 F, thorium is resistant to most liquid metals, with the exception of aluminum. Up to 1472 F, it is notably resistant to sodium-potassium.
- J 1 **Crystal structure.** Face-centered cubic up to 2552 F (1400 C), $a = 5.08$ kX; body-centered cubic above 2552 F.
- K 1 **Mechanical properties.** Average properties of as-cast, bomb-reduced thorium: tensile strength, 31,700 psi; yield strength, 20,900 psi; elongation, 34%; reduction in area, 35%; Vickers hardness (arc-melted iodide), 32 to 42; modulus of elasticity, 7 to 10 million psi. See table.

Tensile Properties of As-Cast Bomb-Reduced Thorium(a)

Value	Tensile strength, psi	Yield strength, psi	Elongation in 1 in., %	Reduction in area, %
Max	48,800	30,100	58	56
Min	23,900	13,800	8	7
Avg	31,700	20,900	34	35

(a) 0.02 to 0.08% C. Yield strength, 110 samples tested; other properties, 107 samples tested.

Source: G. Murphy, R. T. Othmer and R. E. Uhrig, Ames Laboratory, Iowa State University

- N **Casting.** Current melting practice includes: (a) induction melting in a crucible under a protective atmosphere of argon or in a vacuum, and (b) consumable-electrode arc melting in a reduced-pressure argon-helium atmosphere.
- 7 **Hot working temperature.** 1300 to 1750 F (705 to 955 C)
- 11 **Suited to forming** by machining, turning, grinding, threading, drilling, rolling, swaging, forging, drawing and extruding
- 14 **Sintering temperature.** 1830 F (1000 C) in vacuum
- 15 **Heat treatment.** Calcium-reduced metal is annealed by holding at 1200 to 1380 F for 1 hr and slow cooling. Iodide thorium is similarly annealed at 1110 to 1290 F.

Thulium

See page 1230

Tin

See page 1142

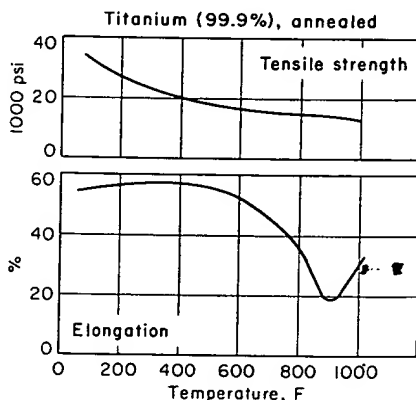
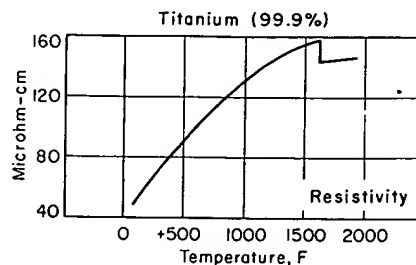
- A 1 **Common name.** Iodide titanium, electrolytic titanium
- B 1 **Typical uses.** Experimentation and research; commercial applications requiring freedom from interstitial alloying elements (oxygen, nitrogen, carbon and hydrogen).
- C 1 **Density at 68 F (20 C).** 0.163 lb per cu in. (4.507 ± 0.005 g per cu cm); beta titanium at 1625 F, 0.156 lb per cu in. (4.35 g per cu cm) (from indirect measurements)
- D 1 **Liquidus temperature.** 3035 ± 18 F (1668 ± 10 C)
- 4 **Boiling point at 1 atmosphere.** 5900 F (3260 C) (estimated)
- 5 **Vapor pressure from 1587 to 1698 K.**
 $\log P = 7.7960 - \frac{24,644}{T} - 0.000227T$
- 6 **Thermal expansion at 68 F (20 C).** 4.67×10^{-6} in./in./°F; at 1832 F, 5.6×10^{-6} in./in./°F (estimated)
- 7 **Thermal expansion in crystallographic direction (calculated from lattice parameters).**

Temperature, F	Direction	Expansion, micro-in./in./°F
68 to 750	Perpendicular to c axis	5.66
68 to 1290	Perpendicular to c axis	6.13
68 to 1290	Along c axis	7.14

- 11 **Specific heat below 13 K (-435 F).**
 C_p (cal/mole/°K) = $8.08 \times 10^{-4} + 0.621 \times 10^{-3}T^3$
 Above room temperature, C_p (cal/mole/°K) = $7.654 - 4.2546 \times 10^{-4}T - 1.236 \times 10^{-5}T^2$

Temp, K	C_p , cal/mole/°K	Temp, K	C_p , cal/mole/°K
50	1.136	500	6.947
75	2.402	550	7.011
100	3.434	600	7.055
125	4.155	650	7.085
150	4.684	700	7.104
175	5.043	750	7.115
200	5.321	800	7.121
225	5.539	850	7.121
250	5.713	900	7.119
275	5.864	950	7.113
298.15	5.976	1000	7.105
300	6.153	1050	7.095
350	6.496	1100	7.084
400	6.711	1150	7.071
450	6.852		

- 13 **Latent heat of fusion.** 5000 cal per mole (estimated)
- 14 **Latent heat of transformation.** 1050 cal per mole (estimated)
- 15 **Latent heat of vaporization.** 112,500 cal per mole (estimated)
- 16 **Thermal conductivity at -400 F.** 6.6 Btu/sq ft/ft/hr/°F
- E 2 **Electrical resistivity at 68 F.** 42.0 microhm-cm; from 68 to 1800 F, see graph.
- 15 **Hall coefficient.** $+1.82 (\pm 0.2) \times 10^{-18}$ volt-cm-amp⁻¹-oersted⁻¹
- 16 **Supraconductivity.** Critical temperature: 0.37 to 0.56 K
- F 5 **Total emissivity.** 0.30 at 1316 F
- G 2 **Magnetic susceptibility at room temperature.** $3.17 (\pm 0.03) \times 10^{-6}$ emu per g
- H 1 **Velocity of sound.** 16,300 ft per sec
- I 1 **General resistance to corrosion.** Better than that of 99.2 and 99.0% Ti alloys (see page 1153)
- J 1 **Crystal structure.** Alpha, hexagonal, close-packed, below 1620 F (882.5 C); beta, body-centered cubic from 1620 F to melting point; alpha: $a = 2.95030$ A, $c = 4.68312$ A, $c/a = 1.5873$; beta: $a = 3.32$ A at 1650 F
- K 1 **Mechanical properties (typical) at room temperature.** Tensile strength, 34,000 psi; 0.2% yield strength, 20,000 psi; elongation in 2 in., 54%; minimum bend radius, less than 1t. See graph for properties at elevated temperatures, top of next column.



Tungsten

Compiled by DALLAS T. HURD†

- B 1 **Typical uses.** As an alloying element in ferrous alloys and tool steels; as filament or sheet in lamps and electron tubes; in missile and space vehicle components (see page 489)
- C 1 **Density at 68 F (20 C).** 19.3 g per cu cm (0.697 lb per cu in.)
- 3 **Compressibility at 68 F (20 C).** 2.8×10^{-7} per megabar. This value is the smallest for any metal.
- D 1 **Melting point.** 6170 F (3410 C)
- 4 **Boiling point.** 10,706 F (5930 C)
- 6 **Thermal expansion.** 4.6 micro-in. per in. per °C at 27 C; 5.2 at 1027 C; 7.3 at 2100 C
- 11 **Specific heat.** 0.033 cal/g/°C
- 12 **Heat capacity.** C_p (cal/deg/mol) = $5.74 + 0.76 \times 10^{-3}t$ ($t = ^\circ K$ over the range from 298 to 2000 K)
- 13 **Heat of fusion.** 44 cal per g
- 15 **Heat of vaporization.** 1150 cal per g
- 16 **Thermal conductivity, cal/cm/sec/°C.**

Value	0	500	1000	2000
	0.397	0.29	0.27	0.25
- 19 **Recrystallization temperature.** 1832 to 2192 F (1000 to 1200 C) for 1 hr, depending on purity and degree of cold work for commercial tungsten, but may range up to more than 3600 F (2000 C) for alloyed or thoriated tungsten.
- 20 **Vapor pressure ($P =$ atmosphere, $t = ^\circ K$).** Solid to melting point, $\log_{10} P = \frac{-47,300}{t} - 1.931 \log t + 15.45$; liquid, $\log P = \frac{-45,600}{t} - 2.01 \log t + 15.25$
- 22 **Entropy at 77 F (25 C).** 8 cal/mol/°C
- E 2 **Electrical resistivity (drawn wire).**

Temp, C	Microhm-cm	Temp, C	Microhm-cm
27	5.65	1827	59.05
327	13.07	2727	90.40
627	21.35	3227	108.5
927	30.26		

- 3 **Work function.** 4.56 ev
- 4 **Electron emission, milliamperes per sq cm.** At 1000 C, 3.2×10^{-10} ; at 2000 C, 3×10^{-2} ; at 3000 C, 84.

*Battelle Memorial Institute

†General Electric Co.